SGC12BS

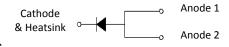
Surface Mount Schottky Rectifier Reverse Voltage 100V Forward Current 12A

Features

- Schottky barrier diodes
- Low forward voltage drop
- · Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s
- Low profile typical height of 1.1 mm
- Heatsink design
- High temperature soldering guaranteed: 260°C/10 seconds
- Halogen-free according to IEC 61249-2-21 definition



eSGC (TO-277)



Typical Applications

For low voltage high frequency inverters, DC/DC converters and polarity protection application.

Maximum Ratings (TA = 25 °C unless otherwise noted)						
Parameter	Symbol	SGC12BS	Unit			
Maximum repetitive peak reverse voltage	VRRM	100	V			
Maximum RMS voltage	VRMS	70	V			
Maximum DC blocking voltage	VDC	100	V			
Maximum average forward rectified current	IF(AV) ¹⁾	5.0	^			
	IF(AV) ²⁾	12.0	Α			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	IFSM	240	А			
Operating junction and storage temperature range	TJ, TSTG	-55 to +150	°C			

Electrical Characteristics (TA = 25 °C unless otherwise noted)									
Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit			
Maximum instantaneous forward voltage	I _F =5A	T _A =25°C	- V _F	0.47	-				
	I _F =12A			0.57	0.70	Valta			
	I _F =5A	T _A =125°C		0.39	-	Volts			
	I _F =12A			0.53	0.65				
Maximum DC reverse current at rated DC blocking voltage	VR=80V	T _A =25°C	l _R	14.9	-	uA			
		T _A =125°C		9.6	-	mA			
	VR=100V	T _A =25°C	l _R	29.5	250	uA			
		T _A =125°C		15.2	30	mA			
Typical junction capacitance	4.0 V, 1 MHz		CJ	290		pF			
Typical thermal resistance	juntion to ambient		R _{θJA} 1)	75		°C/W			
	juntion to mount		R _{θJM} ²⁾	1		°C/W			

Notes,1)Thermal resistance R_{BJA} is junction to ambient. Free air,mounted on P.C.B with recommended copper pad area,2 OZ,FR4

²⁾Thermal resistance R_{BJM} is junction to mount.Mounted on P.C.B with 30*30mm copper pad area

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Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

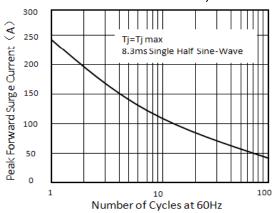


Figure 1.Maximum Non-Repetitive Peak Forward Surge Current

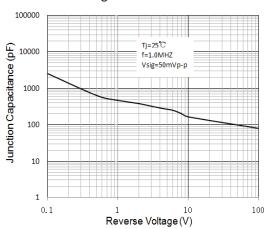


Figure 3. Typical Junction Capacitance

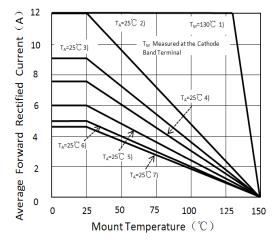


Figure 5. Forward Current Derating Curve

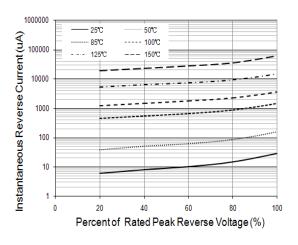


Figure 2. Typical Reverse Characteristics

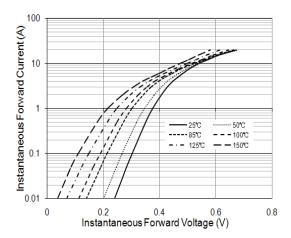


Figure 4. Typical Instantaneous Forward Characteristics

Notes

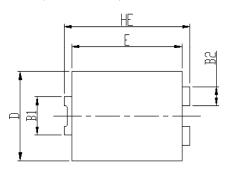
- 1) Mounted on P.C.B with 30*30mm copper pad area
- 2) Mounted on P.C.B with 30*30mm copper pad area (R $_{\theta JA}$ =27 $^{\circ}C/W$)
- 3) Mounted on P.C.B with 30*30mm copper pad area $(R_{RIA}=30^{\circ}C/W)$
- 4) Mounted on P.C.B with 30*30mm copper pad area $(R_{\theta | A}=32^{\circ}C/W)$
- 5) Mounted on P.C.B with 30*30mm copper pad area (R_{RIA} =34°C/W)
- 6) Fre air, Mounted on recommended copper pad area FR4 PCB(R $_{\rm BJA}$ =75 $^{\circ}{\rm C/W}$)
- 7) Fre air, Mounted on recommended copper pad area FR4 PCB(R_{BIA} =76 $^{\circ}$ C/W)



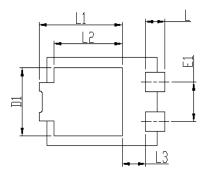
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Package Outline Dimensions

in inches (millimeters)

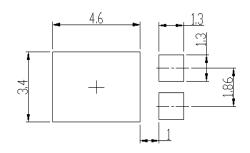






Unit: mm Unit: inch DIM MIN MAX MIN MAX ΗE 6.4 6.6 0.252 0.260 Ε 5.6 5.8 0.220 0.228 D 4.1 4.3 0.161 0.169 В1 1.7 1.9 0.067 0.075 B2 8.0 0.031 0.039 Α 1.05 1.2 0.041 0.047 С 0.3 0.4 0.012 0.016 0.85 1.1 0.033 0.043 L 4.4 L1 4.2 0.165 0.173 L2 3.52 Typ. 0.139 Typ. 0.043 0.055 L3 1.1 1.4 D1 3 3.3 0.118 0.130 E1 1.86 Typ. 0.073 Typ.

Soldering footprint

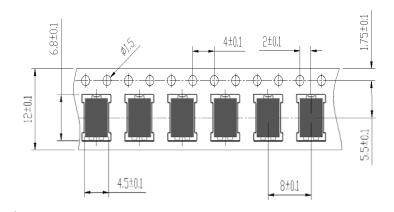


Packing Information

Packing quantities:

5000 pcs/Reel, 12mm Tape, 13" Reel

Tape & Reel Specification



SGC12BS

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